

SIZE	Ę	SYN	PLATED	턴
0.07	2	+	NO	+/-0.003
61.19	4	×	YES	+/-0.003
0.063	•	Ð	YES	+/-0.003
0.094	•	♦	YES	+/-0.003
0.01	7	M	YES	+/-0.003
0.031	92	X	YES	+/-0.003
0.035	2	+	ON	+/-0.003
0.035	ю	4	YES	+/-0.003
0.0311	3)	YES	+/-0.003
0.03	-	4	YES	+/-0.003

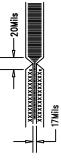
APPR	
	l i
	i
	:
	:
REV	l ,
₩	l

REVISIONS

DATE

NOTES: UNLESS OTHERWISE SPECIFIED:

- 1. ARTWORK P/N Demo Circuit 1276B
- 2. FAB PER IPC-A-600. 4-Layers.
 3. MATERIAL: EPOXY FIBERGLASS, NEMA GRADE FR-4
 .062 +/- .005 INCH THICKNESS WITH 2 0Z.
 COPPER FINISH ON TWO OUTER LAYERS AND
 1 0Z. COPPER ON TWO INTERNAL LAYERS.
 FLAMMABILITY RATING: 94 V-2 MINIMUM.
- 4. SIZE: CUT TO DIMENSIONS AND TOLERANCES SHOWN.
 5. BOARD: SELECTIVE PLATED BOARD. SOLDER
 MASK OVER BARE COPPER, COLOR, GREEN LPI.
 GOLD IMMERSION (ENIG) BOTH SIDES.
 FOR SILKSCREEN: USE WHITE NON-CONDUCTIVE INK.
 PLATE THRU ALL HOLES WITH COPPER
 MIN. PLATING THICKNESS: 1 OZ. EXCEPT
 WHERE PLATING NOT REQUIRED
 6. DRILL: ALL HOLES SHALL BE DRILLED +/-.003 INCH
 WITH RESPECT TO CTR. OF DRILLED PAD.
 ALL HOLES FINISHED SIZE AFTER PLATING.
- DO NOT ALTER ARTWORK e.g. TO ADD LOGO, DATE CODE OR ELECTRICAL TEST STAMP, BUT YOU MAY MODIFY PAD SIZE TO 7
- SCORING FOR PANELIZED PCB: "PRODUCTION RUN ONLY" ∞.



- 9. DO NOT ALTER SOLDER MASK MAINTAIN .0018" OVERSIZE ON SMT PADS. A .005" WEBBING IS REQUIRED BETWEEN SMD PADS.
- 10. PCB'S ARE TO BE ROHS COMPLIANT.

Fabrication Drawing

APPF	APPROVALS	S		TINEM	1630 McCarthy Blvd. Wilbitgs CA 95035
	IN	DATE	1		FECUNO OCY PH: (408)432-1900
DRAWN	LMJ			IECHNOLOG	
CHECK					
DESIGN	SIC		III E	LTC3558EUD Linear USB	aar USB
ENGR	M.Merchan	_	Battery	Battery Charger with Buck and Buck-Boost Regulators	Buck-Boost Regulators
			,		
			SIZE	DC1276B	REV. 1
			NONE		
SCAL	SCALE = NONE	믲	DES-23xxx	:x	SHT 1 of 1